

Q2

2U Passive Heat Sink

PRODUCT SPECIFICATIONS



Model Number: Q2

- Recommend for Intel® CPU as following
 - Intel® Alder Lake S Processor, Socket LGA 1700;
- Passive Heat Sink for 2U Server

Overall Specification

Dimension	90 x 90 x 66 mm
Weight	653±5 g
Material	Copper Base with Aluminum Stacked Fin plus 4 Heat Pipes
Back Strip	Included
Thermal Grease	Pre-Printed with SHIN-ETSU 7762
TDP	Support 150 Watts CPU Power Heat Dissipation

Performance Chart: Q2 Thermal Resistance

Thermal Performance vs. Airflow





